

Features :

- Isolated mounting base 3000V~
- Solder joint technology with increased power cycling capability
- Space and weight saving

Typical Applications

- Various rectifiers
- DC supply for PWM inverter

V_{RSM}	V_{RRM}	品名
900V	800V	MD200D80S
1100V	1000V	MD200D100S
1300V	1200V	MD200D120S
1500V	1400V	MD200D140S
1700V	1600V	MD200D160S
1900V	1800V	MD200D180S

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	$T_J(^{\circ}C)$	VALUE			UNIT
				Min.	Typ.	Max.	
$I_{F(AV)}$	Mean forward current	180° half sine wave 50Hz Single side cooled, $T_C=100^{\circ}C$	150			200	A
$I_{F(RMS)}$	RMS forward current					314	A
I_{RRM}	Repetitive peak current	at V_{RRM}	150			12	mA
I_{FSM}	Surge forward current	10ms half sine wave	150			4	kA
I^2t	I^2t for fusing coordination	$V_R=0.6V_{RRM}$				80	$A^2s \cdot 10^3$
V_{FO}	Threshold voltage		150			0.78	V
r_F	Forward slope resistance					1.10	mΩ
V_{FM}	Peak forward voltage	$I_{FM}=600A$	25			1.60	V
$R_{th(j-c)}$	Thermal resistance Junction to case	D.C. Single side cooled per chip				0.18	$^{\circ}C/W$
$R_{th(c-h)}$	Thermal resistance case to heatsink	D.C. Single side cooled per chip				0.08	$^{\circ}C/W$
V_{iso}	Isolation voltage	50Hz, R.M.S., $t=1min$, $I_{iso}:1mA(max)$		3000			V
F_m	Terminal connection torque(M6)			3.5		5.0	N·m
	Mounting torque(M6)			3.5		5.0	N·m
T_{stg}	Stored temperature			-40		125	$^{\circ}C$
W_t	Weight				150		g
Outline	M17						

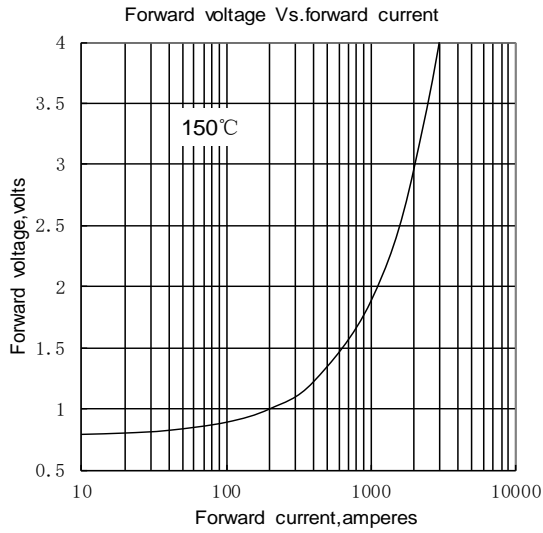


Fig1

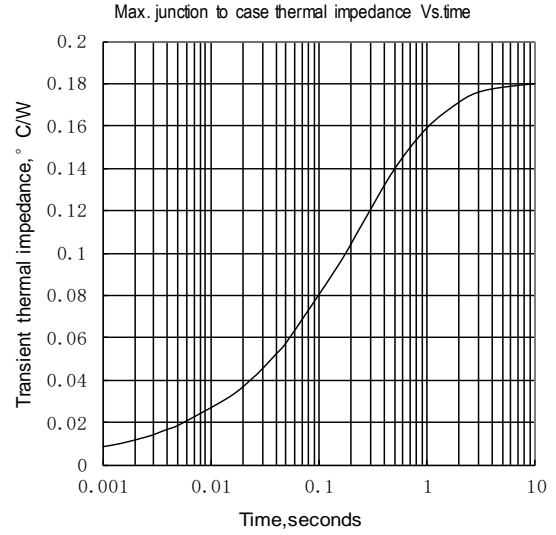


Fig2

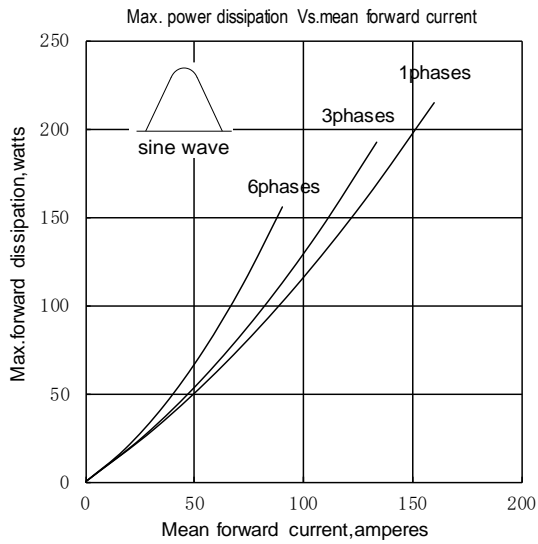


Fig3

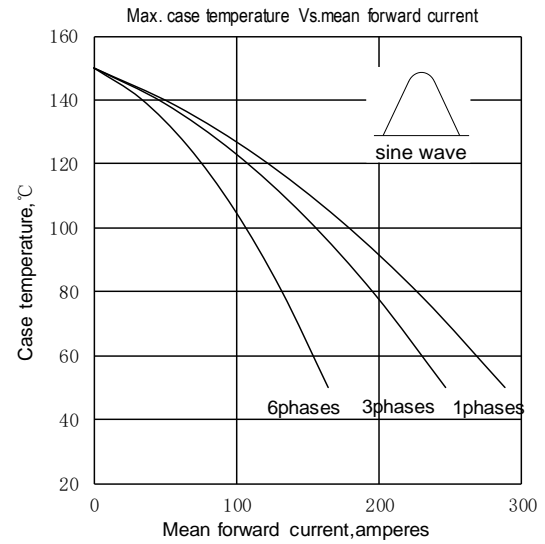


Fig4

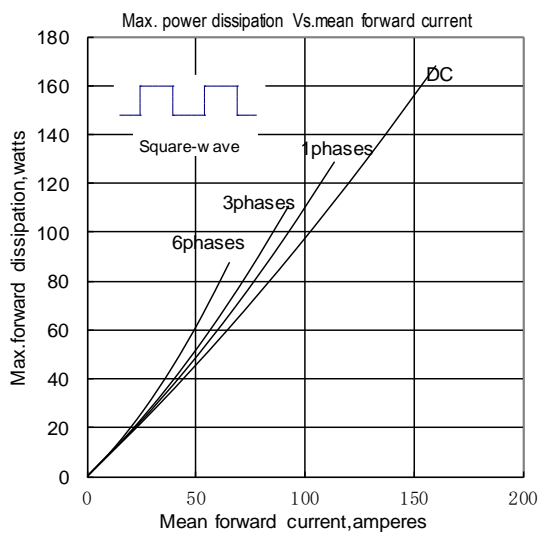


Fig5

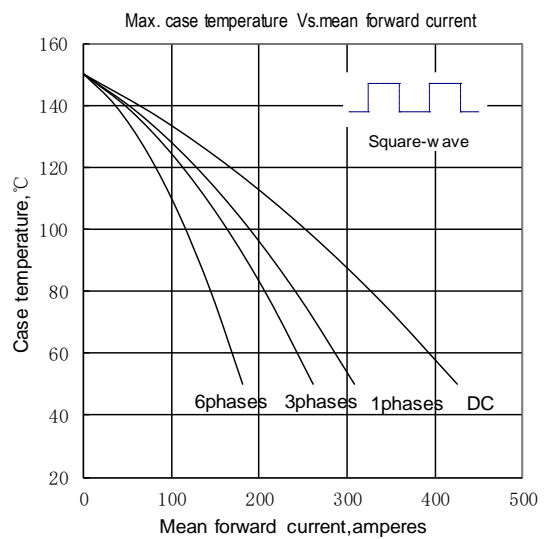


Fig6

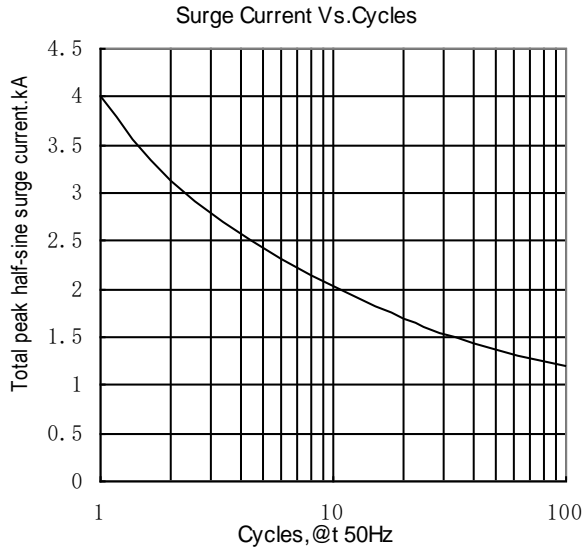
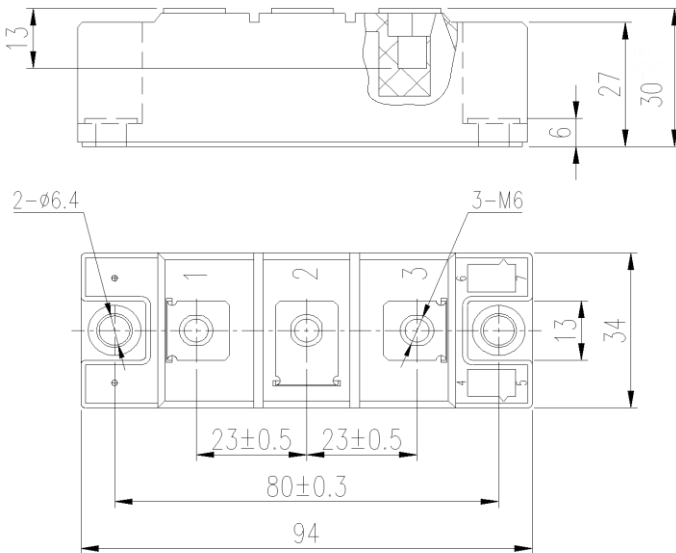
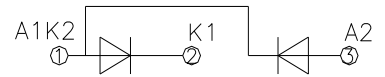


Fig7



MD200D**S



Unmarked dimensional tolerance : ±0.5mm